

# Power Measurements for Computer and Computer Architecture Research



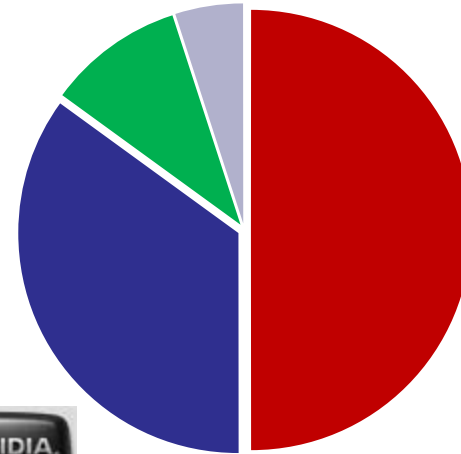
Hyesoon Kim

Georgia  
Tech

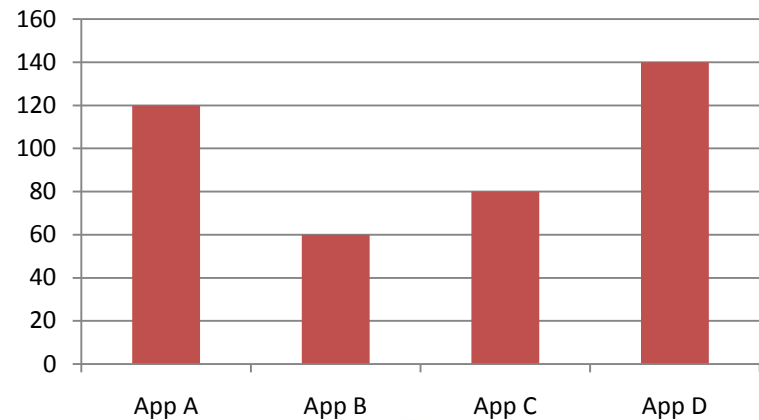


comparch

# Power Measurements



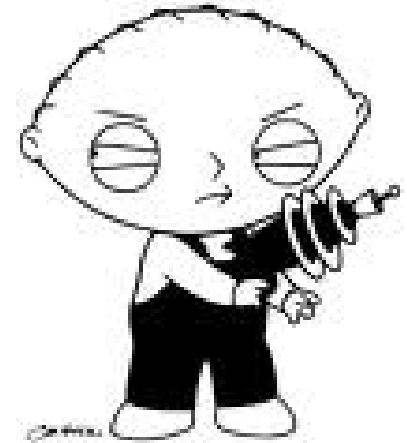
- CPU
- GPU
- HDD
- others



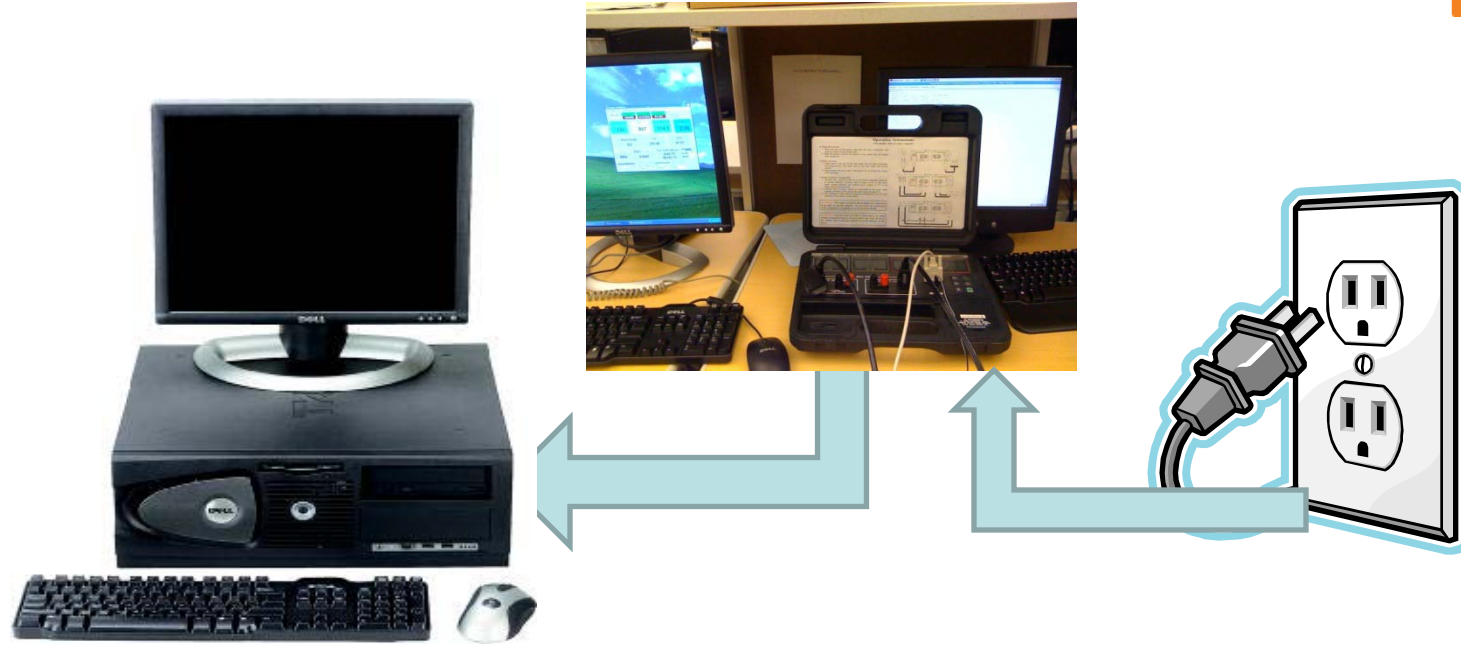
# Measurements



- Power measurements
  - System Input power
  - Module power
  - Board level
- Temperature measurements



# System Power Measurement

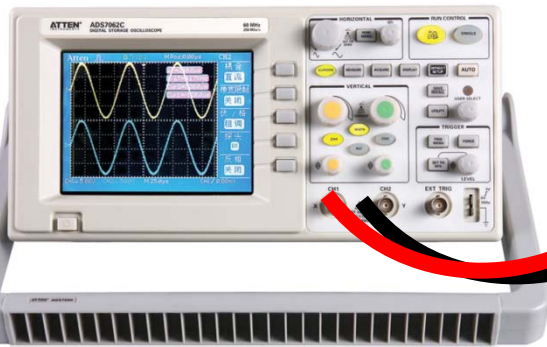


Power = Dynamic power + static power

Dynamic power  $\propto$  dynamic activity

Static power  $\propto$  Area, Temperature

# Module Power: Memory



# Module Power: GPU



# Module Power: CPU



# Board Level Power Measurements



Board level  
Multi-point IR, RF  
measurements

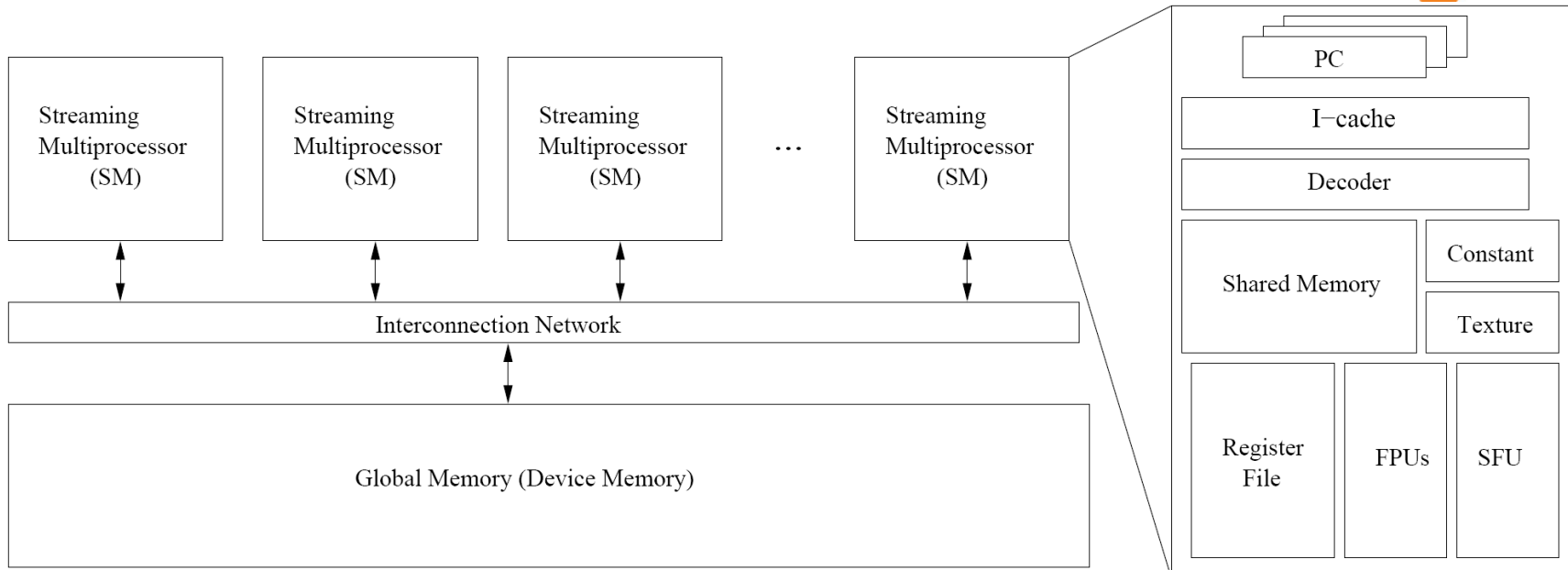




# CASE STUDY: GPU POWER MODEL [ISCA'10]



# Overview of GPU Architecture



- Software-managed cache
- SIMD Execution Unit inside SM

# Power Model



$$\begin{aligned} \text{Total System Power} &= \text{Runtime\_power} + \text{IdlePower} = \sum_{i=0}^n \text{RP\_Component}_i + \text{IdlePower} \\ &= \text{RP\_SMs} + \text{RP\_Memory} + \text{IdlePower} \end{aligned}$$

- Power contributions: SMs, Memory and Idle-power

$$\text{RP\_SMs} = \text{Num\_SMs} \times \sum_{i=0}^n \text{SM\_Component}_i$$

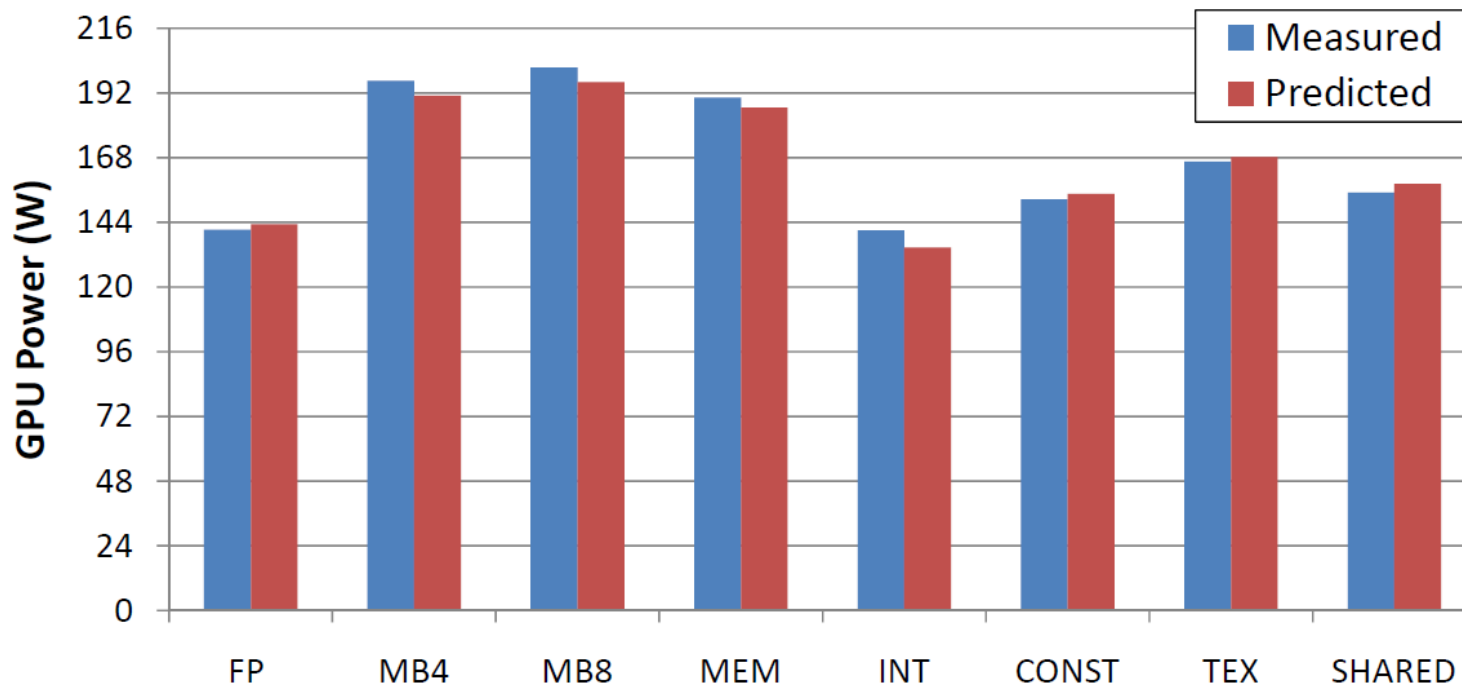
$$\begin{aligned} \sum_{i=0}^n \text{SM\_Component}_i &= \text{RP\_Reg} + \text{RP\_Fp} + \text{RP\_Int} + \text{RP\_Sfu} + \text{RP\_Alu} + \text{RP\_Shared} \\ &\quad + \text{RP\_Const\_SM} + \text{RP\_TextureCache} + \text{RP\_ConstCache} \end{aligned}$$

- Streaming multiprocessor (SM) decomposition

$$\begin{aligned} \text{RP\_Memory} &= \sum_{i=0}^n \text{Memory\_component}_i \\ &= \text{RP\_GlobalMem} \end{aligned}$$

- Memory: Global memory system

# Training Benchmarks To Find Parameters



- Training benchmarks stress particular units of processors, memory

# Power Model

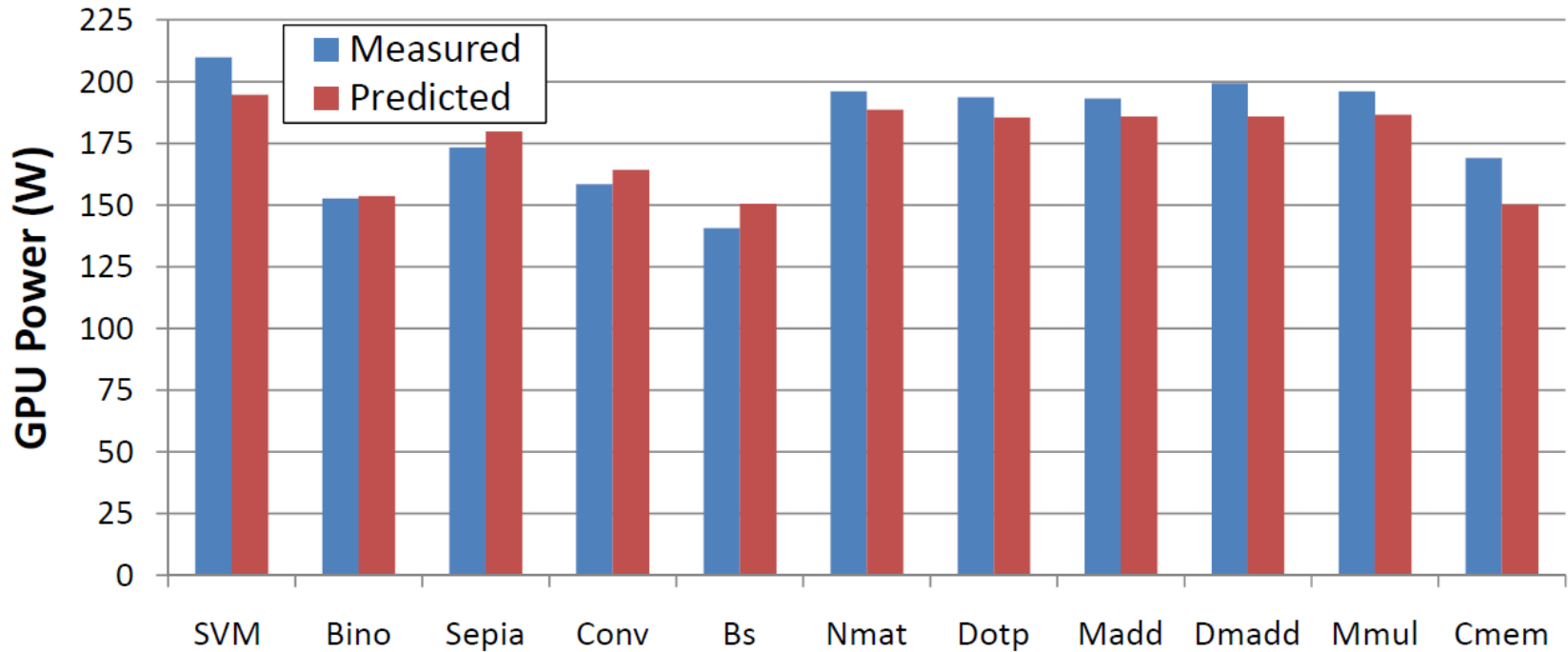


Table 2. Power parameters

Names	MaxPower	OnChip	SpecializedLinear	Term Location
FP	0.2	Yes	Yes	<i>RP_SM</i>
REG	0.3	Yes	Yes	<i>RP_SM</i>
ALU	0.2	Yes	No	<i>RP_SM</i>
SFU	0.5	Yes	No	<i>RP_SM</i>
INT	1	Yes	Yes	<i>RP_SM</i>
FDS (Fetch/Decode/Schedule)	0.5	Yes	Yes	<i>RP_SM</i>
Shared memory	1	Yes	No	<i>RP_SM</i>
Texture cache	0.9	Yes	Yes	<i>RP_SM</i>
Constant cache	0.4	Yes	Yes	<i>RP_SM</i>
Global memory	52	No	Yes	<i>RP_Memory</i>
Const_SM	0.213	Yes	No	<i>RP_SM</i>

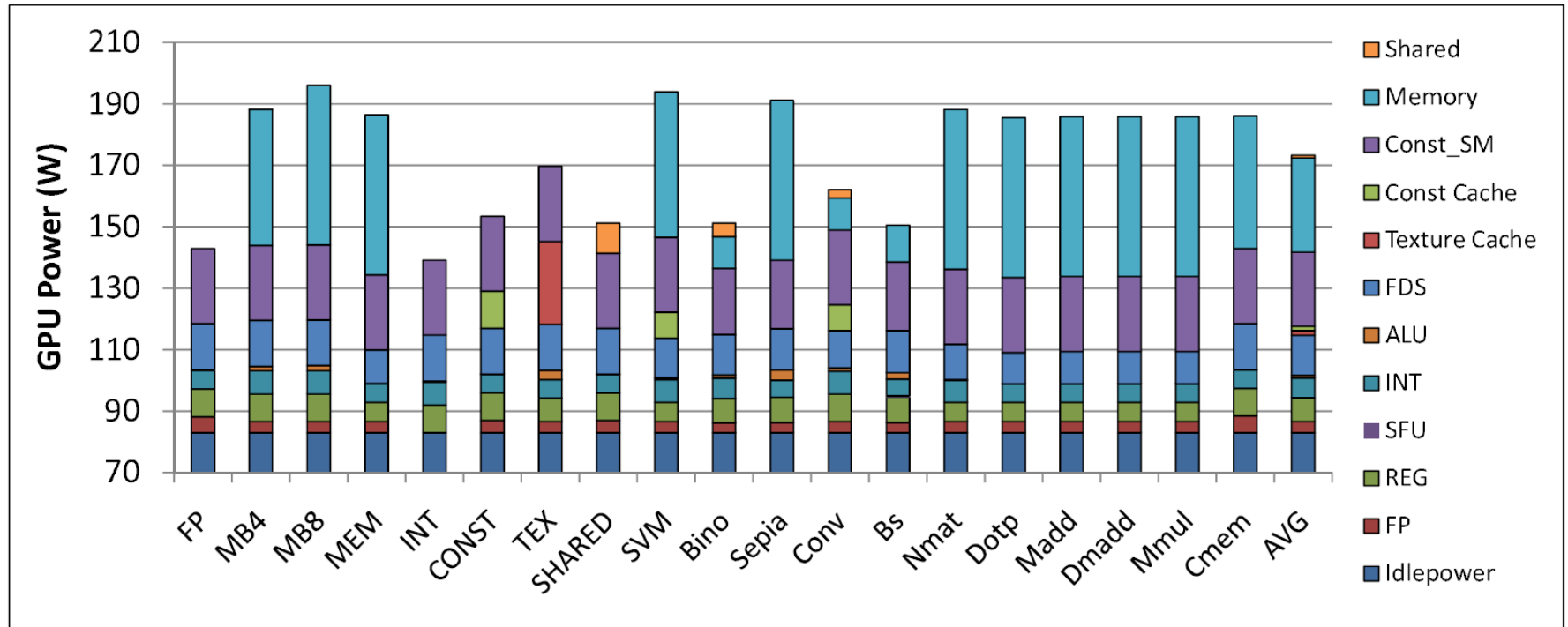
- Power parameters used
- Units inside SM are per SM granularity
- Initial increase from idle to low accessrate causes large power consumption for some units

# Predictions

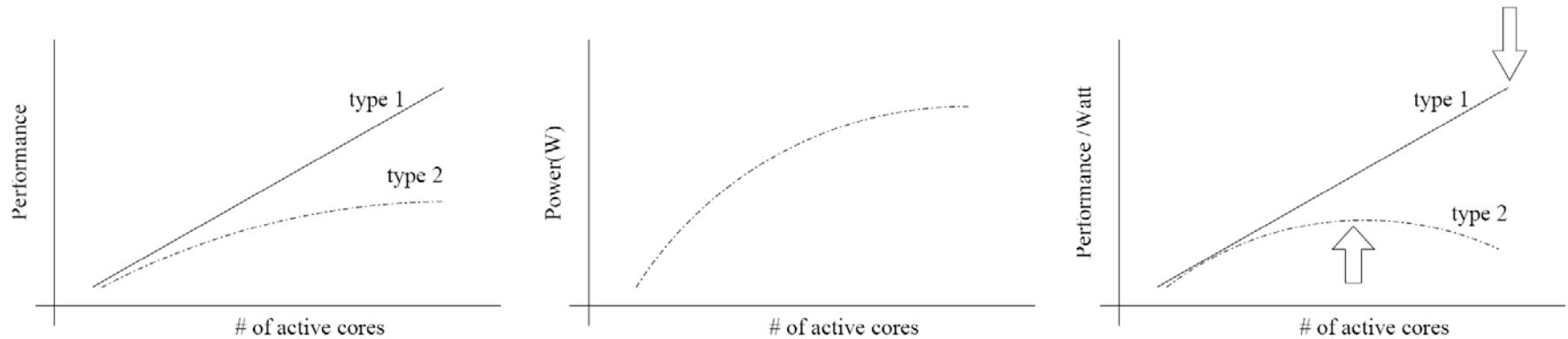




# Power Consumption Breakdown



# Usage 1: Find Optimal Number of Cores

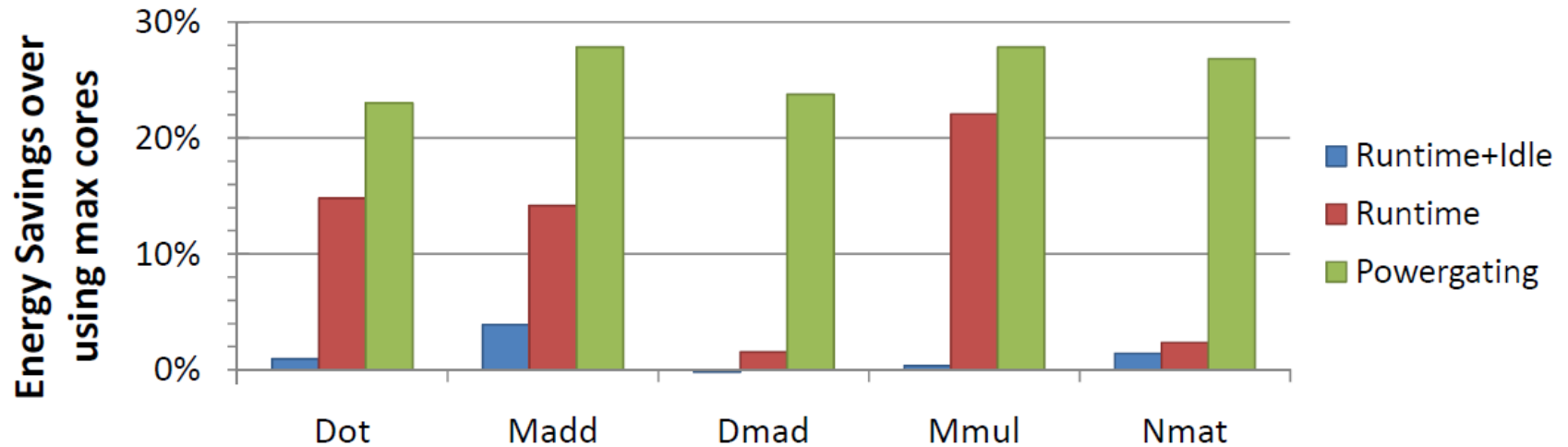


- Performance, Power and Efficiency vs. Number of Active Cores
- Type 1 **utilizes** all the cores (Performance increases linearly)
- Performance for type 2 **saturates** (Due to bandwidth limitations)





# Results

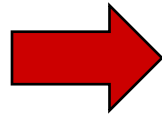
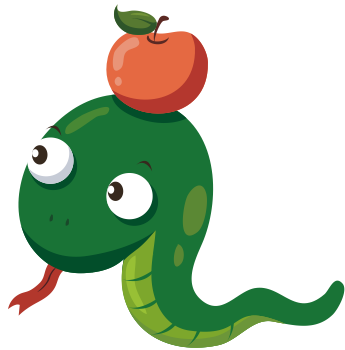


- Energy savings using optimal number of cores based on IPP system (NVIDIA GTX 280 and power gating GPUs)

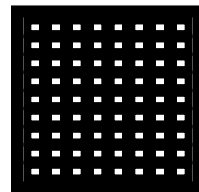
# Usage 2: Dynamic Mapping



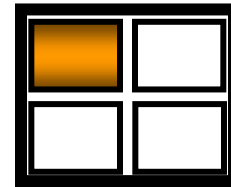
- Distribute work between CPU and GPU for power and performance



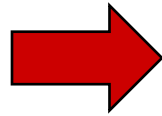
CASE 1



GPU



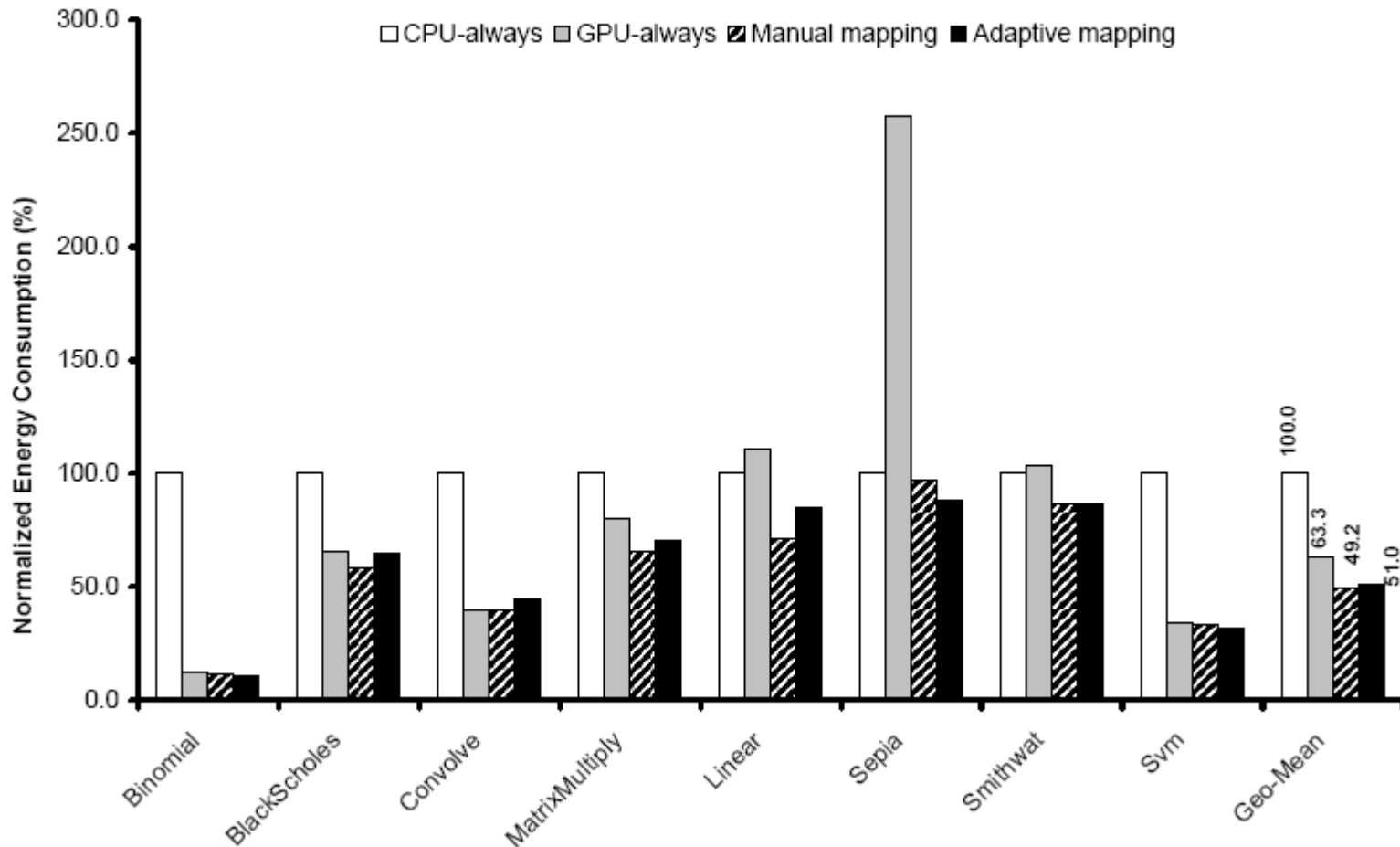
CPU



CASE 2

Luk & Hong & Kim MICRO'09

# Energy Consumption





# TEMPERATURE MEASUREMENTS



# Using Thermal Camera

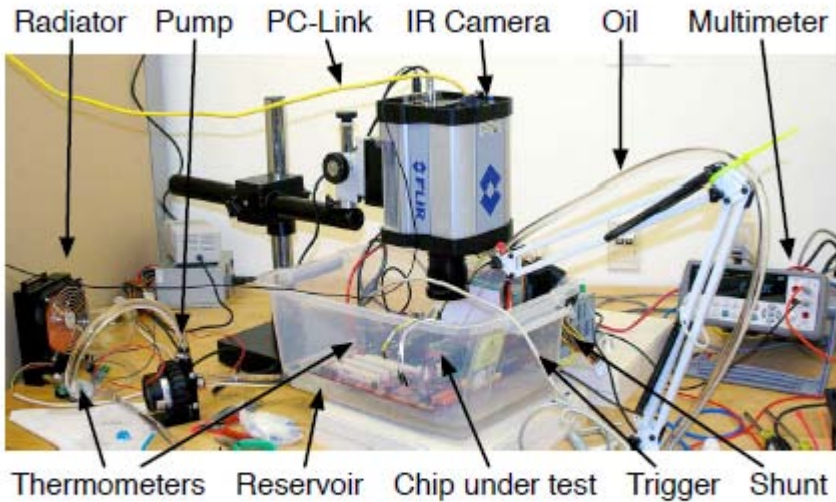


Figure 1: Measuring setup

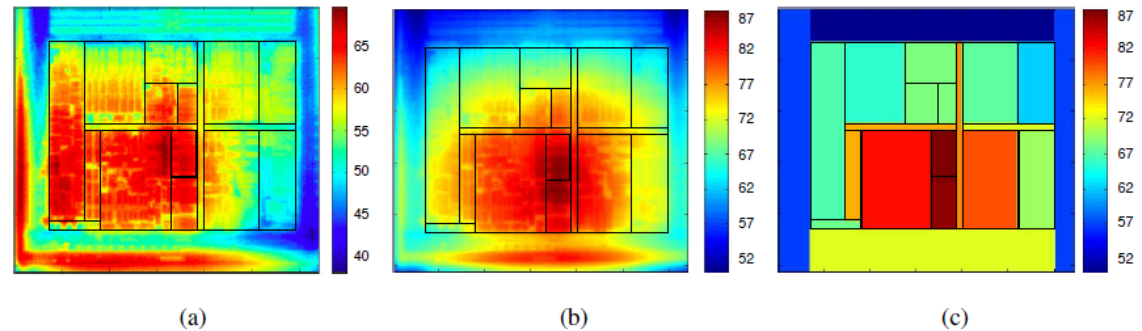
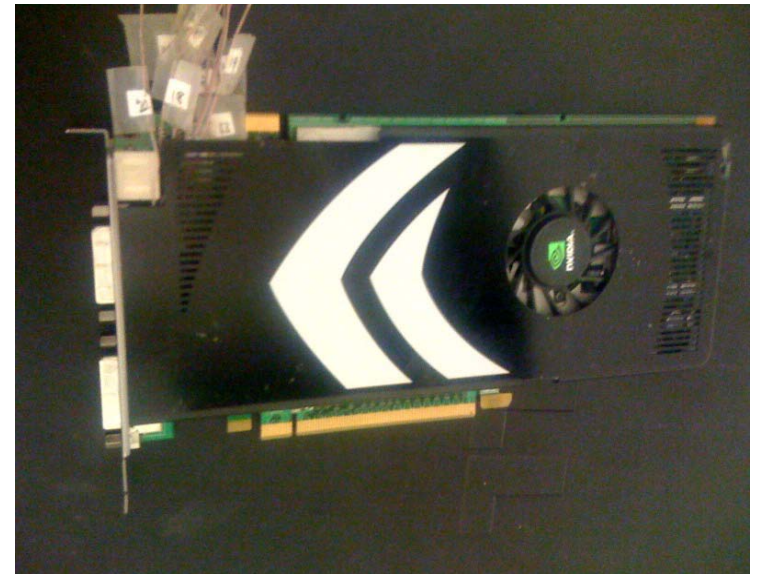
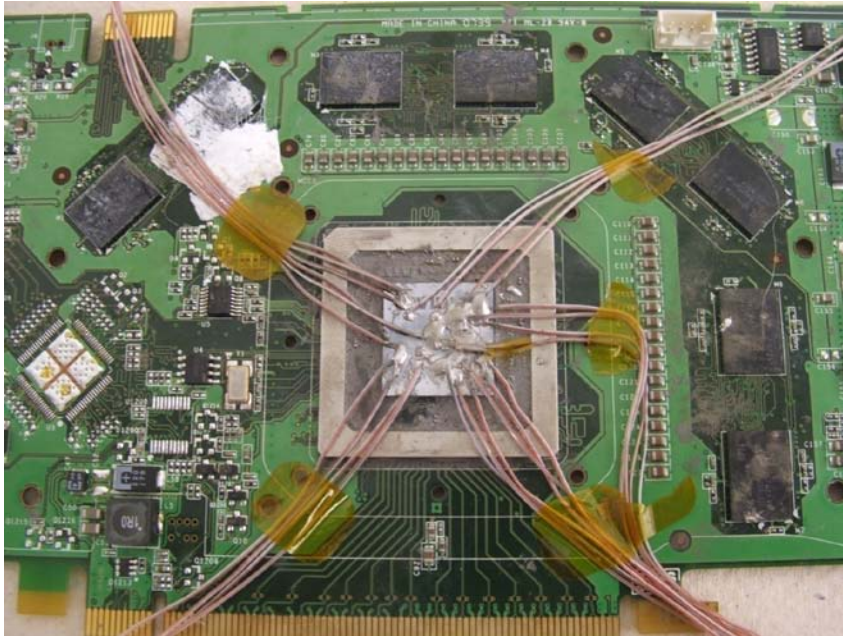


Figure 3: Full-thermal image with overlapped floorplan (a); hottest captured image (b); and its average temperature per block (c).

# Using Thermocouples



With Thermocouples, the original case can be assembled so we can measure power & temp behavior with the original heat sink

# On-going Researches Topcis



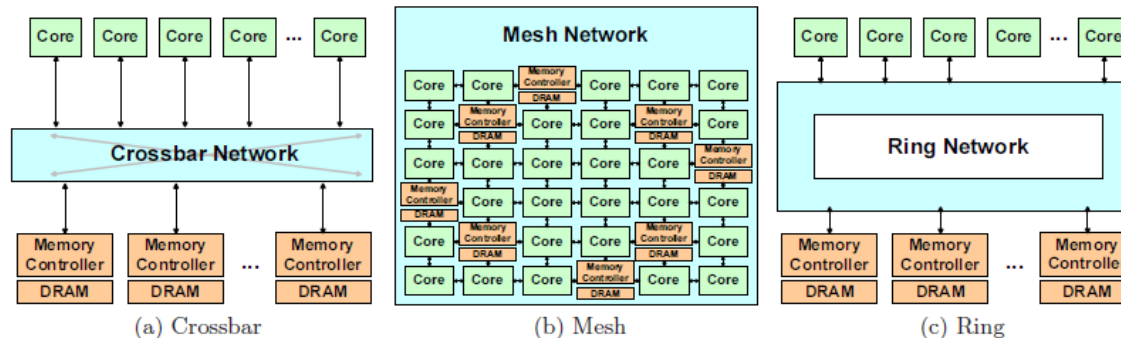
- Thread scheduling policies
- DVFS managements

H	C	C	H
C	C	C	C
C	C	C	C
H	C	C	H

H	H	C	C
H	H	C	C
C	C	C	C
C	C	C	C

H: running hot jobs, C: cold jobs or low voltage, turn-off power

- Multi-core lay out design to reduce thermal gradient, effective thermal transfers



- Leakage power model (combine with themperature model)



# Conclusions

- Power & temperature measurements opens an new architecture research
  - Architecture design (not only performance but also power)
  - Application scheduling, resource managements
  - Dynamic compilation system
- **Experimental measurements and simulations** together can extend more wider range of research



# Dream Lab



- Power measurement systems
  - Current–probed oscilloscopes
  - IR measurement systems
  - Current measurement controllers
- Probe stations
- Temperature measurements
  - Thermal image camera, oil cooling system
  - Multiple of thermocouple measurement systems
- Facility
  - Humidity, temperature controlled room
  - High current power supply
- Custom boards, custom riser cards

